



1F AF
January 20, 2009

TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Attn: Art Unit 2892 - Examiner Arora, Ajay

FROM: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

SUBJECT: Serial #: 10/802,566
File Date: 03/17/2004
Inventor: Mou-Shiung Lin
Examiner: Arora, Ajay
Art Unit: 2892
Title: A High Performance IC Chip having Discrete Decoupling
Capacitors Attached to its IC Surface

RESPONSE TO FINAL OFFICE ACTION

Dear Sir:

In response to the Final Office Action mailed Oct. 17, 2008, please amend the above-identified application for patent and consider the remarks as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents P.O. Box 1450, Alexandria, VA 22313-1450 on Jan. 20, 2009.

Signature 
Stephen B. Ackerman, Reg. No. 37,761

Date: January 20, 2009

Amendments to the Claims are reflected in the listing of the Claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 19 of this paper.